

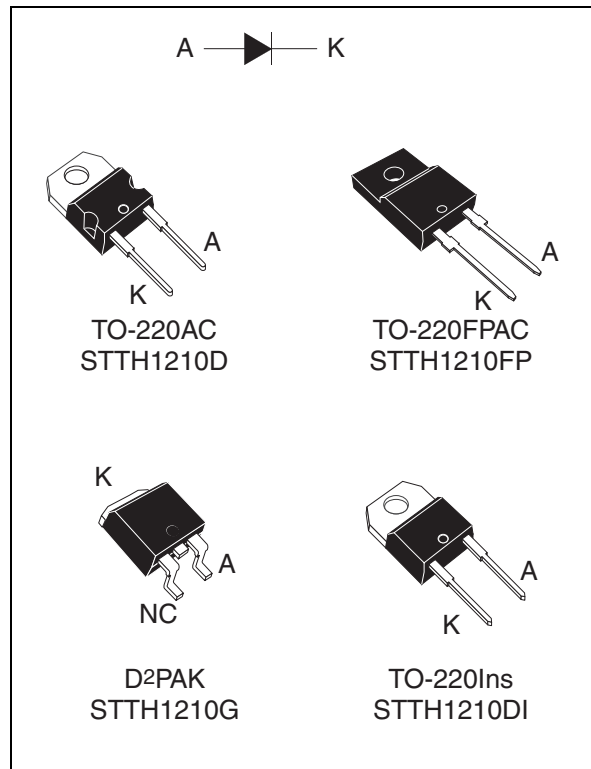
Ultrafast recovery - high voltage diode

Main product characteristics

$I_{F(AV)}$	12 A
V_{RRM}	1000 V
T_j	175° C
V_F (typ)	1.30 V
t_{rr} (typ)	48 ns

Features and benefits

- Ultrafast, soft recovery
- Very low conduction and switching losses
- High frequency and/or high pulsed current operation
- High reverse voltage capability
- High junction temperature
- Insulated packages:
 - TO-220Ins
Electrical insulation = 2500 V_{RMS}
Capacitance = 7 pF
 - TO-220FPAC
Electrical insulation = 2500 V_{RMS}
Capacitance = 12 pF



Description

The high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability.

Such demanding applications include industrial power supplies, motor control, and similar mission-critical systems that require rectification and freewheeling. These diodes also fit into auxiliary functions such as snubber, bootstrap, and demagnetization applications.

The improved performance in low leakage current, and therefore thermal runaway guard band, is an immediate competitive advantage for this device.

Order codes

Part Number	Marking
STTH1210D	STTH1210D
STTH1210G	STTH1210G
STTH1210G-TR	STTH1210G
STTH1210FP	STTH1210FP
STTH1210DI	STTH1210DI

1 Characteristics

Table 1. Absolute ratings (limiting values at 25° C, unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		1000	V
$I_{F(RMS)}$	RMS forward current	TO-220AC / D ² PAK / TO-220FPAC	30	A
		TO-220AC Ins	20	
$I_{F(AV)}$	Average forward current, $\delta = 0.5$	TO-220AC / D ² PAK	12	A
		$T_c = 125^\circ \text{C}$		
		TO-220FPAC		
		$T_c = 40^\circ \text{C}$		
		TO-220AC Ins		
		$T_c = 95^\circ \text{C}$		
I_{FRM}	Repetitive peak forward current	$t_p = 5 \mu\text{s}$, $F = 5 \text{ kHz}$ square	120	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms}$ Sinusoidal	80	A
T_{stg}	Storage temperature range		-65 to + 175	°C
T_j	Maximum operating junction temperature		175	°C

Table 2. Thermal parameters

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case	TO-220AC / D ² PAK	1.9	°C/W
		TO-220FPAC	5.4	
		TO-220AC Ins	3.1	

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25^\circ \text{C}$	$V_R = V_{RRM}$			10	μA
		$T_j = 125^\circ \text{C}$			3	30	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25^\circ \text{C}$	$I_F = 12 \text{ A}$			2.0	V
		$T_j = 100^\circ \text{C}$			1.40	1.8	
		$T_j = 150^\circ \text{C}$			1.30	1.7	

1. Pulse test: $t_p = 5 \text{ ms}$, $\delta < 2 \%$

2. Pulse test: $t_p = 380 \mu\text{s}$, $\delta < 2 \%$

To evaluate the conduction losses use the following equation:

$$P = 1.3 \times I_{F(AV)} + 0.033 I_{F(RMS)}^2$$

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ	Max.	Unit
t_{rr}	Reverse recovery time	$I_F = 1\text{ A}$, $di_F/dt = -50\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$, $T_j = 25^\circ\text{C}$		67	90	ns
		$I_F = 1\text{ A}$, $di_F/dt = -100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$, $T_j = 25^\circ\text{C}$		48	65	
I_{RM}	Reverse recovery current	$I_F = 12\text{ A}$, $di_F/dt = -200\text{ A}/\mu\text{s}$, $V_R = 600\text{ V}$, $T_j = 125^\circ\text{C}$		15	20	A
S	Softness factor	$I_F = 12\text{ A}$, $di_F/dt = -200\text{ A}/\mu\text{s}$, $V_R = 600\text{ V}$, $T_j = 125^\circ\text{C}$		2		
t_{fr}	Forward recovery time	$I_F = 12\text{ A}$, $di_F/dt = 50\text{ A}/\mu\text{s}$, $V_{FR} = 1.5 \times V_{Fmax}$, $T_j = 25^\circ\text{C}$			400	ns
V_{FP}	Forward recovery voltage	$I_F = 12\text{ A}$, $di_F/dt = 50\text{ A}/\mu\text{s}$, $T_j = 25^\circ\text{C}$		5		V

Figure 1. Conduction losses versus average current

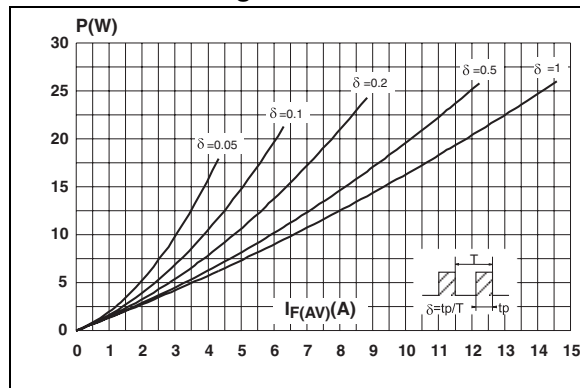


Figure 2. Forward voltage drop versus forward current

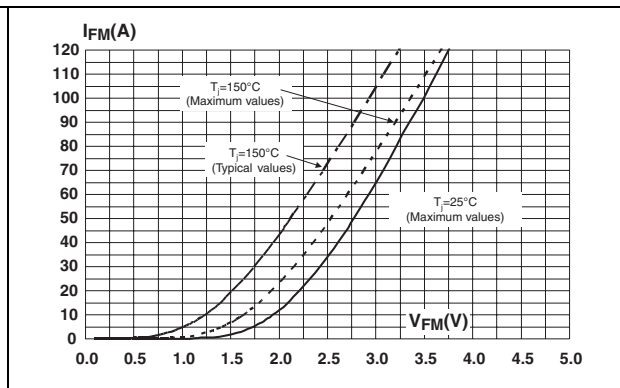


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

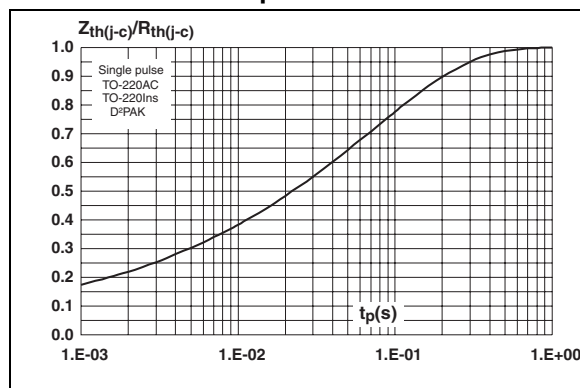


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration

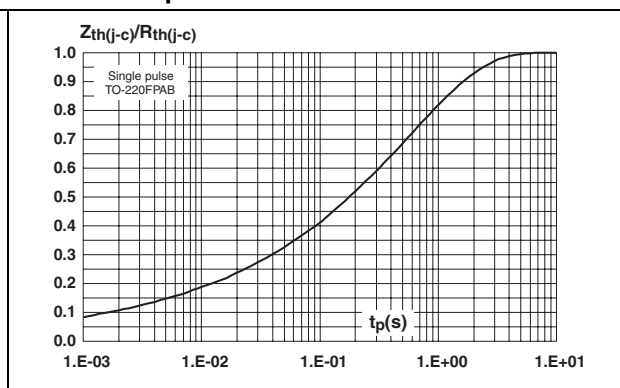


Figure 5. Peak reverse recovery current versus dl_F/dt (typical values)

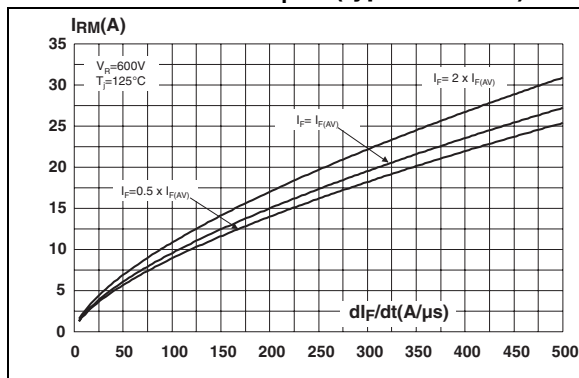


Figure 6. Reverse recovery time versus dl_F/dt (typical values)

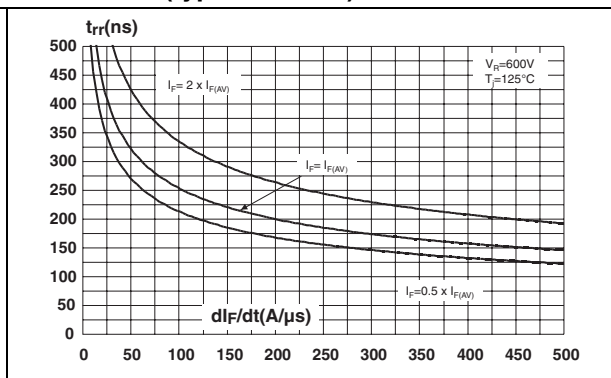


Figure 7. Reverse recovery charges versus dl_F/dt (typical values)

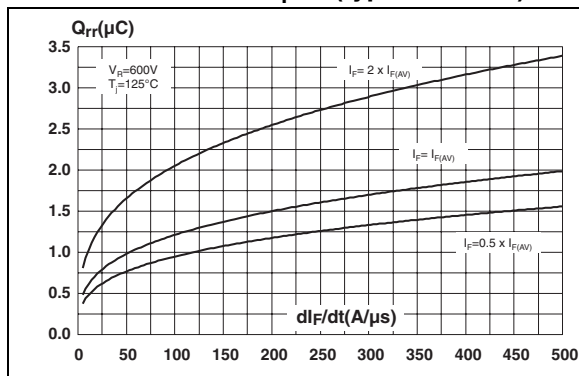


Figure 8. Softness factor versus dl_F/dt (typical values)

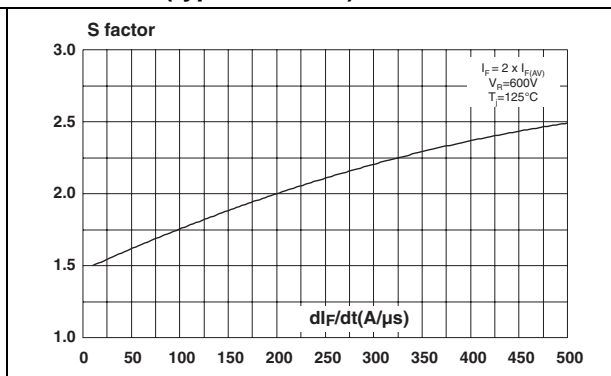


Figure 9. Relative variations of dynamic parameters versus junction temperature

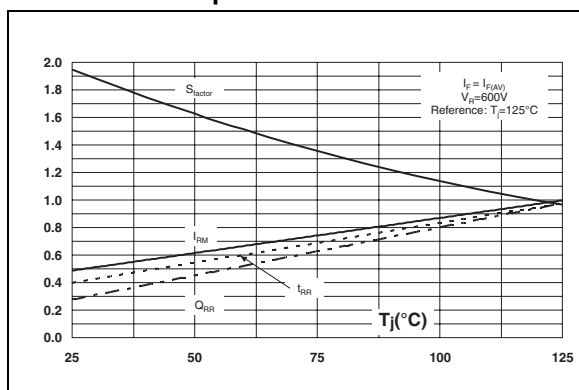


Figure 10. Transient peak forward voltage versus dl_F/dt (typical values)

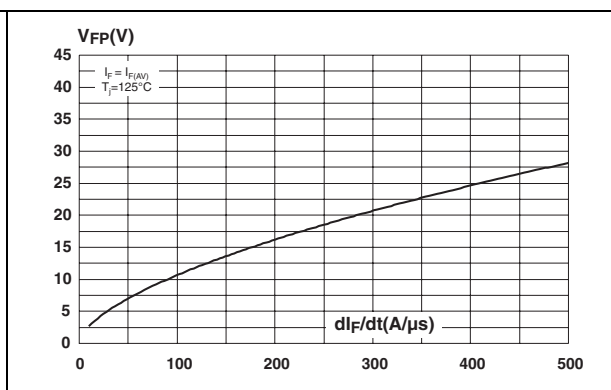


Figure 11. Forward recovery time versus dI_F/dt (typical values)

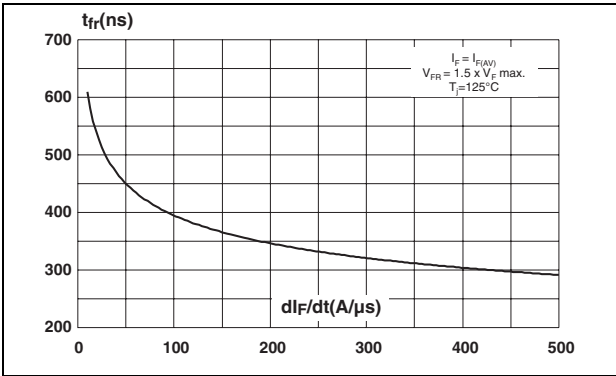


Figure 12. Junction capacitance versus reverse voltage applied (typical values)

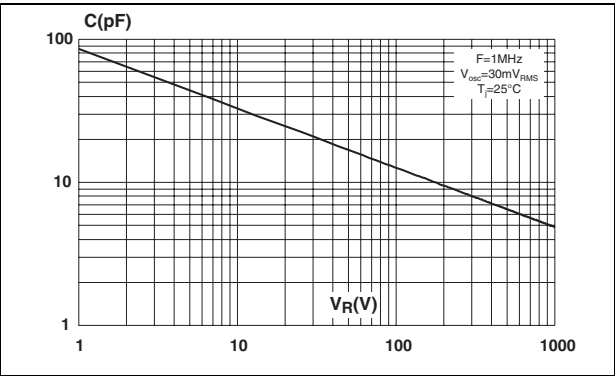
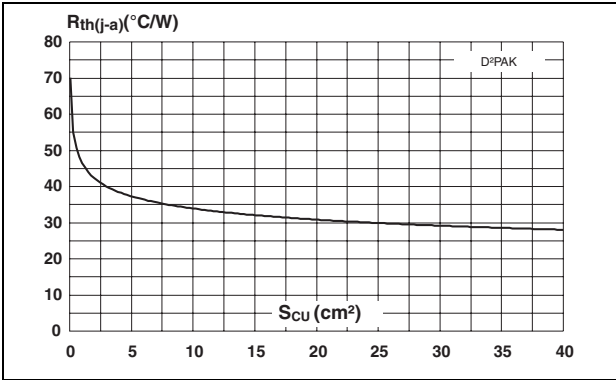


Figure 13. Thermal resistance junction to ambient versus copper surface under tab (Epoxy printed circuit board FR4, $e_{Cu} = 35 \mu\text{m}$)



2 Package information

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Recommended torque value: 0.55 Nm (TO-220AC, TC-220Ins, TO-220FPAC)

Maximum torque value: 0.7 Nm (TO-220AC, TO-220Ins, TO-220FPAC)

Table 5. T0-220AC dimensions

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
H2	10.00	10.40	0.393	0.409
L2	16.40 typ.		0.645 typ.	
L4	13.00	14.00	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam. I	3.75	3.85	0.147	0.151

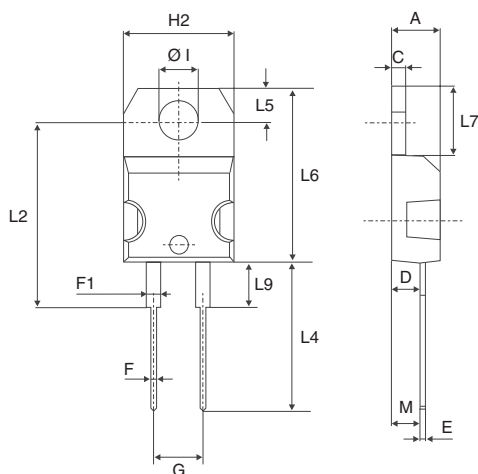
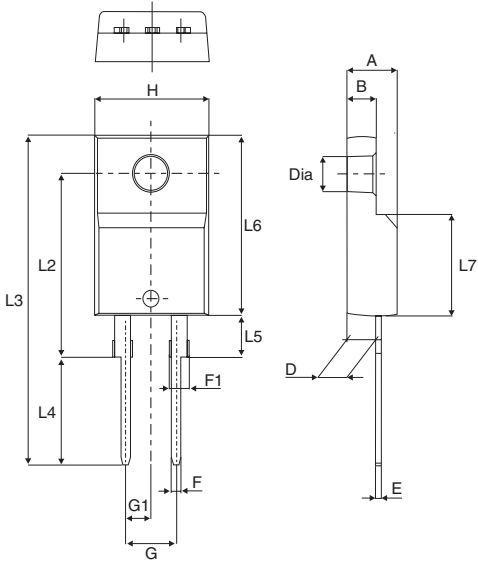


Table 6. T0-220Ins dimensions

REF	DIMENSIONS					
	Millimeters			Inches		
	Min.		Max.	Min.		Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	4.80		5.40	0.189		0.212
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
l4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
l2	1.14		1.70	0.044		0.066
M		2.60			0.102	

Table 7. T0-220FPAC dimensions

REF	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.4	4.6	0.173	0.181
B	2.5	2.7	0.098	0.106
D	2.5	2.75	0.098	0.108
E	0.45	0.70	0.018	0.027
F	0.75	1	0.030	0.039
F1	1.15	1.70	0.045	0.067
G	4.95	5.20	0.195	0.205
G1	2.4	2.7	0.094	0.106
H	10	10.4	0.393	0.409
L2	16 Typ.		0.63 Typ.	
L3	28.6	30.6	1.126	1.205
L4	9.8	10.6	0.386	0.417
L5	2.9	3.6	0.114	0.142
L6	15.9	16.4	0.626	0.646
L7	9.00	9.30	0.354	0.366
Dia.	3.00	3.20	0.118	0.126



The technical drawing illustrates the T0-220FPAC package. The top view shows a rectangular body with a central circular feature and four mounting pins. Dimensions A through H define the top view's geometry. The side view shows the package's profile, including the mounting pins and the body's height. Dimensions L2 through L7 define the side view's geometry. The diameter (Dia.) is indicated for the central circular feature.

Technical drawing of a 1/2" NPT female fitting. The drawing includes a top view and a side view. The top view shows the fitting with dimensions L, L2, L3, E, G, B, and B2. The side view shows the fitting with dimensions A, A1, A2, C, C2, D, R, and V2. A detail view of the thread shows a 2mm min. flat zone and a 2mm min. flat zone.

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max	Min.	Max.
A	4.40	4.60	0.173	0.181
A1	2.49	2.69	0.098	0.106
A2	0.03	0.23	0.001	0.009
B	0.70	0.93	0.027	0.037
B2	1.14	1.70	0.045	0.067
C	0.45	0.60	0.017	0.024
C2	1.23	1.36	0.048	0.054
D	8.95	9.35	0.352	0.368
E	10.00	10.40	0.393	0.409
G	4.88	5.28	0.192	0.208
L	15.00	15.85	0.590	0.624
L2	1.27	1.40	0.050	0.055
L3	1.40	1.75	0.055	0.069
M	2.40	3.20	0.094	0.126
R	0.40 typ.		0.016 typ.	
V2	0°	8°	0°	8°

Technical drawing showing the front and side views of a mechanical part with the following dimensions:

- Overall width: 16.90
- Overall height: 10.30
- Base width: 8.90
- Side view width: 3.70
- Side view height: 5.08
- Side view detail height: 1.30



3 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STTH1210D	STTH1210D	TO-220AC	1.86 g	50	Tube
STTH1210DI	STTH1210DI	TO-220Ins	1.86 g	50	Tube
STTH1210FP	STTH1210FP	TO-220FPAC	2.2 g	50	Tube
STTH1210G	STTH1210G	D ² PAK	1.48 g	50	Tube
STTH1210G-TR	STTH1210G	D ² PAK	1.48 g	1000	Tape & reel

4 Revision history

Date	Revision	Description of Changes
02-Mar-2006	1	First issue.

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